(rov.9/95)

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My mailing address and citizenship are as stated below next to my name.

I believe I am the original first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled METHOD FOR FORMING NON-VOLATILE MEMORY CELL WITH LOW-TEMPERATURE-FORMED DIELECTRIC BETWEEN WORD AND BIT LINES, AND NON-VOLATILE MEMORY ARRAY INCLUDING SUCH MEMORY CELLS, the specification of which

	one)

- [X] is attached hereto
-) was filed on

as US Application Serial Number

I hereby state that I have reviewed and understand the contents of the above identified application, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability as defined in 37 CFR § 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT International application which designated at least one country other than the United States, itsed below and have also identified below any foreign application for patent or inventor's certificate, or PCT International application having a filling date before that of the application on which priority is claimed.

Prior Foreign Application(s)

Priority Not Claimed

(Number)	(Country)	(Day/Month/Year Filed)	[]
(Number)	(Country)	(Day/Month/Your Filed)	[]

I hereby claim the benefit under 35 U.S.C. §119(e) of any United States provisional application(s) listed below.

(Application Number) (Filing Date)
(Application Number) (Filing Date)

I hereby claim the benefit under 35 U.S.C. §120 of any United States application(s), or §365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. §112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR §1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

(Application Number) (Filing Date) (Status -parented, pending, abandones)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Donald E. Stout. Reg. No. 34,493; Frank J. Uxa, Reg. No. 25,612; Robert O. Buyan, Reg. No. 32,460,

Kegton R. Mullins, Reg. No. 36,331; Jo Anne M. Ybaben, Reg. No. 42,243; Linda Allyson Fox, Reg. No. 38,883; Kyle D. Yesland, Reg. No. 45,526; Greg S. Hollrigel, Reg. No. 45,374; Louise S. Helm, Reg. No. 32,337.

Address all telephone calls to Address all correspondence to Kenton R. Mullins at telephone number (949) 450-1750; facsimile number (949) 450-1764

Kenton R. Mullins

Stout, Uxa, Buyan & Mullins, LLP

4 Vonture, Suite 300 Irvine, CA 92618

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that those statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment. or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may Jeopardize the validity of the application or any

patent issued thereon.

Fa Shinng Han inventor's signature

FU SHIUNG HSU

2007, 6, 70

Citizenship

Date

Republic of China

Mailing Address

16 Li-Hsin Rd., Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

Inventor's signature

Chen chi'u Liu

CHEN CHIN LIU Date

Republic of China Citizenship

16 Li-Hsin Rd., Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C. Mailing Address

Lan Ling Huang Inventor's signature

2003.6.30 Date

Republic of China Citizenship

16 Li-Hsin Rd., Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C. Mailing Address